

# Part Number: XZMG46W-8

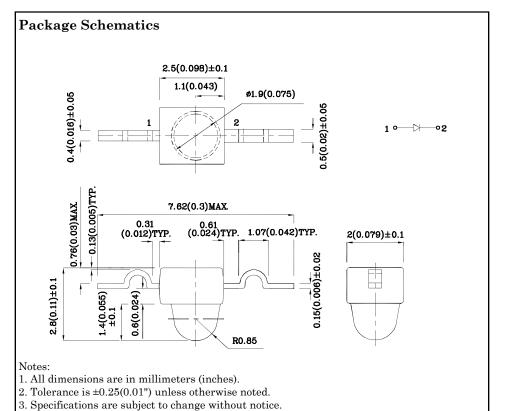
### SUBMINIATURE SOLID STATE LAMP

#### **Features**

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- $\bullet$  Moisture sensitivity level : level 3
- Package : 1000pcs / reel
- RoHS compliant







Absolute Maximum Ratings ( $T_A$ =25°C)		MG (GaP)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	V	
Forward Current	$I_{\mathrm{F}}$	25	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA	
Power Dissipation	$P_{D}$	62.5	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	U	

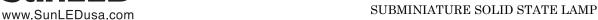
Operating Characteristics (T <sub>A</sub> =25°C)		MG (GaP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.2	V	
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	V	
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	uA	
Wavelength of Peak Emission (Typ.) (I <sub>F</sub> =20mA)	λΡ	565	nm	
Wavelength of Dominant Emission (Typ.) (I <sub>F</sub> =20mA)	λD	568	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	30	nm	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	15	pF	

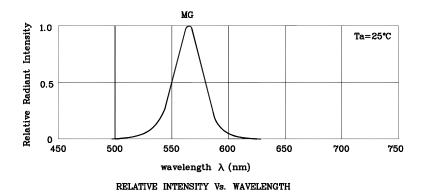
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity $(I_F=20 \mathrm{mA})$ $\mathrm{mcd}$		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZMG46W-8	Green	GaP	Water Clear	50	98	565	20°

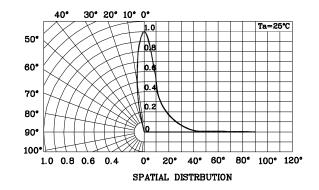
Feb 01,2011 XDSA1739 V7 Layout: Maggie L.



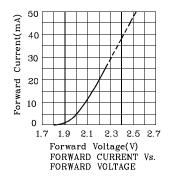


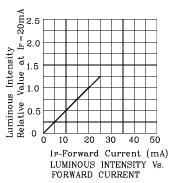


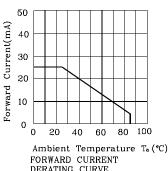


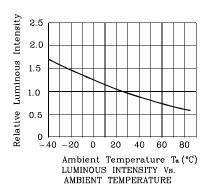


### **♦** MG



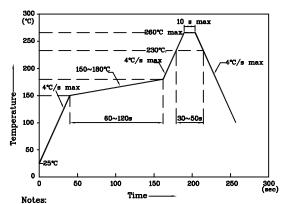






# LED is recommended for reflow soldering and soldering profile is shown below.

#### Reflow Soldering Profile for SMD Products (Pb-Free Components)

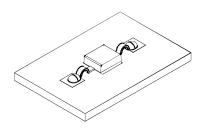


- 1. Maximum soldering temperature should not exceed 260°C
- Recommended reflow temperature: 145°C-260°C
- Do not put stress to the epoxy resin during high temperatures conditions

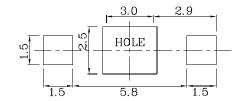




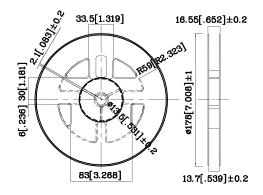
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



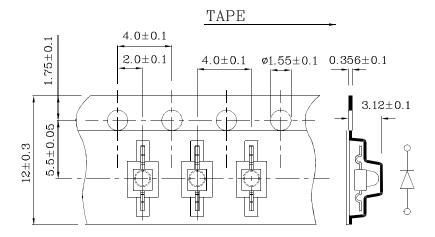
**❖** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **❖** Reel Dimension



# **❖** Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

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- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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# PACKING & LABEL SPECIFICATIONS

